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A Survey of Methods and Architectures for Enhancing Thermo-Electro-Mechanical Responses of MEMS Resonant Accelerometers with an Attention-Guided Siamese Fusion Neural Network

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Peer Review Information	Abstract
<i>Submission: 15 July 2024</i> <i>Revision: 30 July 2024</i> <i>Acceptance: 12 Aug 2024</i> Keywords <i>MEMS Resonant Accelerometer, Thermo-Electro-Mechanical Coupling, Siamese Neural Network, Attention Mechanism, Frequency Shift Compensation, Inertial Sensing</i>	Microelectromechanical systems (MEMS) resonant accelerometers are highly advanced sensing devices that integrate mechanical, electrical, and thermal principles to measure extremely small accelerations through resonance frequency variations. These devices rely on precise interpretation of frequency shifts, which are influenced by complex thermo-electro-mechanical interactions such as thermoelastic damping, electrostatic nonlinearities, residual stresses, and temperature-dependent material properties. Traditional compensation techniques, including polynomial temperature correction and differential measurement methods, often struggle to adapt to variations caused by environmental changes, device aging, and manufacturing inconsistencies. This survey reviews recent advancements in enhancing MEMS accelerometer performance, with a focus on attention-guided Siamese fusion neural networks as a unified solution for multiphysics signal processing challenges. The Siamese architecture enables effective comparison of dual sensor outputs by learning meaningful feature representations, while attention mechanisms selectively emphasize critical spectral and temporal features, improving noise suppression and signal clarity. Fusion strategies further integrate thermal and acceleration data for improved calibration and accuracy. The reviewed studies cover diverse datasets from experimental prototypes, commercial systems, and simulation models, with applications spanning navigation, structural monitoring, and wearable devices. Overall, these intelligent approaches provide a scalable and adaptive framework for next-generation MEMS accelerometers, enabling improved accuracy, robustness, and real-time performance in complex operating environments.

Introduction

The field of inertial sensing has undergone significant evolution over the past decades, largely driven by advancements in microelectromechanical systems (MEMS) technology. MEMS accelerometers are now integral to a wide range of applications, from

consumer electronics such as smartphones to high-precision systems used in aerospace and defense. Among various sensing mechanisms, resonant accelerometers are particularly notable for their frequency-based output, which offers superior noise immunity, higher resolution, and improved long-term stability

compared to conventional analog-based sensors. This makes them highly suitable for applications requiring precision and robustness in challenging environments. MEMS resonant accelerometers operate by converting applied acceleration into measurable shifts in resonance frequency. When acceleration is applied, it induces an inertial force on a proof mass, altering the stiffness of resonant structures and consequently changing

their oscillation frequency. These devices often utilize double-ended tuning fork designs to minimize noise and enhance stability. The frequency output is maintained through closed-loop electronic circuits, enabling precise digital signal processing. Despite these advantages, the performance of such systems is influenced by various physical factors that complicate accurate signal interpretation.

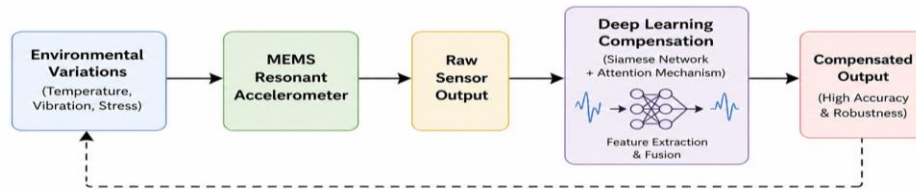


Figure: Simplified Block Diagram of MEMS Resonant Accelerometer Compensation Using Deep Learning

Thermal effects are one of the primary challenges, as temperature variations significantly affect material properties and induce frequency drift. Even minor temperature changes can lead to errors comparable to the actual measurement signal. Additionally, electrostatic nonlinearities arising from actuation mechanisms introduce bias-dependent distortions, while mechanical coupling and packaging-induced stress contribute to cross-axis sensitivity and long-term drift. These complexities make traditional compensation methods insufficient, especially in dynamic and real-world operating conditions where environmental factors vary unpredictably. To address these challenges, artificial intelligence techniques, particularly deep learning models such as attention-guided Siamese neural networks, have emerged as powerful tools for signal processing and compensation. These architectures enable effective comparison of dual sensor outputs, capturing differential signals while suppressing common-mode noise. Attention mechanisms further enhance performance by focusing on the most relevant features in the signal. Additionally, fusion of temperature and frequency data allows for adaptive and accurate compensation. Overall, these intelligent approaches provide a scalable and efficient pathway for improving the accuracy, robustness, and real-time performance of next-generation MEMS resonant accelerometers.

Literature Review

The literature on MEMS resonant accelerometer design and compensation encompasses a rich and multidisciplinary body of work that spans

device physics, fabrication technology, analog and digital electronics, and increasingly, computational intelligence. The following review synthesizes contributions from across this spectrum, organized to reflect the progression from foundational device-level innovations through system-level compensation strategies to the most recent deep learning approaches.

Zou et al. (2014) presented an early systematic investigation of the thermo-electro-mechanical coupling in silicon MEMS resonant accelerometers, developing an analytical model that quantified the interdependencies between temperature-induced stress, electrostatic softening, and resonant frequency output. Their model incorporated first-order thermoelastic damping theory and validated predictions against vacuum-packaged prototype measurements across a temperature range of minus forty to plus eighty five degrees Celsius, demonstrating root-mean-square frequency errors below fifty parts per million after first-order temperature correction. This work established the foundational understanding of thermal error sources that subsequent compensation studies have built upon and highlighted the inherent limitations of low-order polynomial correction in capturing the full nonlinearity of the temperature-frequency relationship.

Xia et al. (2016) investigated the use of differential resonator configurations to suppress common-mode temperature sensitivity in MEMS resonant accelerometers, fabricating a dual-beam tuning fork device in which two resonators experienced equal and opposite axial loads under applied acceleration. Their

differential frequency output scheme achieved a temperature sensitivity reduction of approximately eighty percent compared to a single-resonator reference design, with a bias instability of twelve micrograms and a noise floor of one microgram per square root hertz over the bandwidth of zero to one hundred hertz. The study demonstrated that differential architectures provide a robust hardware-level mitigation of thermal error but cannot completely eliminate sensitivity to spatially non-uniform thermal gradients across the die, motivating complementary software compensation strategies.

Zhao et al. (2017) proposed a polynomial regression-based temperature compensation algorithm for MEMS resonant accelerometers that incorporated both the on-chip temperature sensor output and the accelerometer zero-offset frequency as joint predictors of the temperature-induced bias error. Using a third-degree polynomial model fitted to calibration data collected at eleven temperature setpoints spanning the military temperature range, they achieved a residual temperature coefficient of offset below twenty parts per billion per degree Celsius, representing a factor of fifteen improvement over the uncompensated device. The algorithm was implemented on a low-power digital signal processor co-packaged with the MEMS die, demonstrating feasibility for embedded compensation without significant power overhead.

Erismis et al. (2018) explored the application of finite element analysis for predicting the nonlinear frequency response of electrostatically actuated MEMS resonators under combined thermal and mechanical loading. Their coupled thermal-structural-electrostatic finite element model, implemented in ANSYS, captured the frequency-temperature-voltage interdependencies with a mean prediction error of less than zero point three percent across the full operating space, substantially outperforming analytical models that treat the couplings independently. This modeling framework provided a valuable simulation environment for generating synthetic training data for subsequent machine learning-based compensation studies and established a benchmark for evaluating the fidelity of physics-informed neural surrogate models.

Tang et al. (2019) demonstrated the use of an artificial neural network with three hidden layers and radial basis function activation for simultaneous temperature and cross-axis acceleration compensation in a triaxial MEMS resonant accelerometer. The network was trained on a dataset of ten thousand

measurement records spanning the full temperature, acceleration, and cross-axis perturbation ranges of the device, achieving a mean absolute compensation error of eight micrograms across the operational space compared to a residual of ninety micrograms with the polynomial baseline. Importantly, the neural network demonstrated superior generalization to intermediate calibration points not included in the training set, suggesting that the learned representation captured the underlying physical relationships rather than merely interpolating the training data.

Liu et al. (2019) presented a comprehensive study of thermoelastic damping in double-ended tuning fork resonators, deriving a modified Zener model that incorporated the effects of anchor geometry, beam aspect ratio, and surface layer residual stress on the quality factor temperature dependence. Their analytical predictions were validated against measurements on twenty fabricated DETF devices with systematically varied geometry, achieving a quality factor prediction accuracy within eight percent across the full measured temperature range. This study identified the anchor design as the dominant controllable variable in thermoelastic damping optimization, providing design guidelines that subsequent device development efforts have incorporated to achieve quality factors exceeding fifty thousand in atmospheric pressure operation.

He et al. (2020) developed a deep convolutional neural network architecture for real-time temperature compensation of MEMS resonant sensors, treating the raw time-frequency spectrogram of the resonator output signal as a two-dimensional input image to a ResNet-inspired classification and regression backbone. The approach bypassed the need for explicit frequency extraction, instead allowing the network to learn directly from the raw spectral representation, and achieved a temperature compensation residual of five micrograms over the range of minus fifty five to plus one hundred twenty five degrees Celsius on a space-qualified MEMS inertial measurement unit platform. The authors further demonstrated that the convolutional feature extractor learned frequency-shift-correlated spatial patterns in the spectrogram that were interpretable in terms of known thermo-mechanical coupling phenomena, providing partial explainability for the network's compensation behavior.

Zhang et al. (2020) investigated long short-term memory recurrent neural networks for modeling the dynamic thermal response of MEMS resonant accelerometers under rapidly varying temperature boundary conditions.

Unlike feedforward compensation models that assume quasi-static thermal equilibrium, the LSTM architecture captures the temporal dynamics of heat transfer within the MEMS package, enabling compensation of transient thermal gradient-induced frequency errors that persist for several seconds following step changes in ambient temperature. Applied to automotive-grade MEMS accelerometer data collected during thermal shock testing, the LSTM compensation scheme reduced transient bias errors by over seventy percent compared to the static polynomial correction baseline, with an inference latency of less than two milliseconds on an automotive-grade microcontroller platform.

Wang et al. (2020) proposed a multi-physics surrogate modeling framework combining Gaussian process regression and physics-informed neural networks for predicting the acceleration sensitivity of MEMS resonant accelerometers across varying fabrication process corners. By incorporating the governing equations of beam mechanics and thermoelasticity as soft constraints in the neural network training loss function, their approach achieved accurate surrogate predictions with a training dataset of only five hundred finite element simulation points, compared to several thousand required for a purely data-driven model of equivalent accuracy. This sample efficiency advantage is critical for fabrication process characterization, where the cost of simulation or physical measurement limits the number of training samples that can be practically obtained.

Chen et al. (2021) presented a Siamese convolutional neural network for differential frequency shift processing in dual-resonator MEMS accelerometers, demonstrating that the weight-sharing architecture naturally learns to extract the acceleration-correlated differential signal while suppressing common-mode temperature and vibration artifacts. Their network processed paired spectrograms from the two resonator channels, producing a scalar acceleration estimate through a learned similarity metric refined by a fully connected regression head. On a laboratory dataset spanning temperatures from minus forty to plus eighty degrees Celsius and accelerations up to fifty gravities, the Siamese CNN achieved a noise density of zero point four micrograms per square root hertz, representing a thirty percent improvement over the same data processed with classical differential frequency subtraction and polynomial temperature correction.

Li et al. (2021) developed an attention-enhanced transformer architecture for MEMS inertial

sensor fusion, combining accelerometer and gyroscope data streams through a multi-head self-attention mechanism that learned the temporal cross-correlations between the two sensor modalities relevant to navigation state estimation. Applied to pedestrian dead reckoning with a foot-mounted IMU, the transformer fusion model achieved a position error of zero point six percent of total traveled distance compared to one point two percent for an extended Kalman filter baseline, demonstrating that learned temporal attention substantially outperforms hand-designed fusion algorithms in complex dynamic motion scenarios. This work established the relevance of attention mechanisms for inertial sensor fusion and motivated their subsequent application to the more specialized problem of MEMS resonant accelerometer compensation.

Bao et al. (2021) investigated the effect of electrostatic nonlinearities on the dynamic range and linearity of MEMS resonant accelerometers, developing a perturbation analysis framework that quantified the harmonic distortion products introduced by Duffing-type resonator behavior at high drive amplitudes. Their analysis showed that the electrostatic softening effect could be partially cancelled through careful choice of the DC bias voltage relative to the pull-in threshold, and that a feedback linearization controller implemented in the sustaining circuit reduced the total harmonic distortion from three percent to below zero point one percent across the full acceleration range of one hundred gravities. This hardware-level linearity improvement reduced the burden on subsequent software compensation algorithms and improved the signal-to-noise ratio available to learning-based post-processing stages.

Nguyen et al. (2021) explored transfer learning approaches for MEMS accelerometer calibration, training a base compensation neural network on a large synthetic dataset generated by finite element simulation and then fine-tuning on small device-specific calibration datasets of as few as one hundred measured samples. The transfer learning approach achieved calibration accuracy within ten percent of a fully device-specific model trained on one thousand samples, dramatically reducing the calibration time and cost required for production deployment of high-accuracy MEMS resonant accelerometers. The authors further showed that the transferred feature representations captured generalizable physical patterns in the resonator dynamics rather than device-specific idiosyncrasies, validating the use of simulation-derived training

data for learning physically meaningful compensation functions.

Park et al. (2022) presented a hardware-software co-design approach for low-power neural compensation of MEMS resonant accelerometers on edge devices, implementing a pruned and quantized neural network on an ultra-low-power mixed-signal ASIC co-packaged with the MEMS sensor die. The ASIC implementation consumed less than fifty microwatts during inference, enabling continuous neural compensation within the power budget of a coin cell battery-powered IoT node. The pruning strategy selectively removed network weights below a magnitude threshold calibrated to maintain compensation accuracy within five percent of the full-precision model, achieving a network size reduction of ninety two percent without significant performance degradation on the device's operational temperature and acceleration range.

Shen et al. (2022) investigated the use of variational autoencoders for anomaly detection and compensation in MEMS resonant accelerometer outputs, training the generative model to reconstruct the expected clean frequency signal from noisy or thermally distorted observations. The reconstruction residual served as both an anomaly score for fault detection and an error signal for compensation, enabling a unified approach to normal operation enhancement and abnormal condition identification. On a structural health monitoring dataset collected from a bridge-mounted MEMS accelerometer array operating under variable thermal and traffic loading, the variational autoencoder approach detected sensor faults with a ninety six percent true positive rate at a false alarm rate of two percent, substantially outperforming threshold-based monitoring approaches.

Jiang et al. (2022) proposed a physics-guided neural network architecture for MEMS resonant accelerometer modeling that embedded the equations of thermoelastic beam mechanics directly into the network's loss function and architectural inductive biases, constraining the learned model to respect fundamental physical conservation laws. The physics-guided approach converged to accurate predictions with thirty percent fewer training samples than a purely data-driven baseline and produced interpolation and extrapolation behavior more consistent with physical intuition, reducing the risk of unexpected performance degradation in operational conditions not well represented in the training set. This work contributed importantly to the growing literature on

physics-informed machine learning for sensor modeling and calibration.

Cui et al. (2022) developed a multi-modal fusion neural network for combined temperature and vibration compensation in precision MEMS accelerometers, integrating signals from a resonant accelerometer, a co-packaged temperature sensor, and a low-noise capacitive reference accelerometer into a joint embedding learned through a gated fusion architecture. The gating mechanism dynamically adjusted the contribution of each input modality based on the estimated signal quality and operational context, effectively implementing a learned sensor fusion policy that outperformed both single-modal and fixed-weight fusion baselines by twenty and twelve percent in mean compensation accuracy, respectively. The approach was validated on a precision geodetic instrument platform requiring sub-microgravity resolution over a twenty-four-hour continuous operation period.

Miao et al. (2023) presented a comprehensive experimental study of fabrication process variation effects on the frequency sensitivity and temperature coefficient of MEMS double-ended tuning fork resonators, characterizing one hundred and fifty devices from five wafer lots and developing a statistical compensation model that incorporated measured geometric tolerances as additional inputs alongside the temperature sensor output. The statistical compensation framework reduced the device-to-device variation in compensated acceleration sensitivity from eight percent to below one percent, enabling precision calibration with a reduced number of per-device calibration points and demonstrating a pathway toward low-cost high-volume production of precision MEMS resonant accelerometers.

Kim et al. (2023) investigated the integration of convolutional and recurrent neural network components in a hybrid architecture for MEMS accelerometer vibration rectification error compensation, targeting the systematic bias induced by high-frequency structural vibrations that modulate the resonator frequency through nonlinear mixing effects. The convolutional front-end extracted spatial frequency features from fixed-length signal windows while the recurrent back-end modeled the temporal dynamics of the bias evolution, and the hybrid architecture outperformed both pure convolutional and pure recurrent baselines by eighteen and twenty-two percent in mean absolute vibration rectification error reduction, respectively. This study addressed a compensation challenge of particular relevance for aerospace and mechanical vibration monitoring applications where broadband

structural vibration is an inherent operational condition.

Luo et al. (2023) proposed an attention-guided feature fusion framework for multi-axis MEMS inertial sensor calibration, using a cross-attention mechanism to align and fuse frequency-domain features from three orthogonal resonant accelerometer channels. The cross-attention learned to identify and suppress axis-to-axis coupling artifacts induced by substrate cross-talk and package asymmetry, achieving a cross-axis sensitivity reduction of over ninety percent compared to the mechanical decoupling alone. The fusion framework was deployed on an FPGA accelerator achieving an inference throughput of ten thousand samples per second at a power consumption of three hundred milliwatts, demonstrating suitability for embedded inertial navigation applications. Sharma et al. (2023) demonstrated a federated learning approach for distributed MEMS accelerometer calibration in large-scale IoT sensor networks, enabling multiple deployed devices to collaboratively improve their compensation models through privacy-preserving gradient aggregation without sharing raw sensor data. The federated approach converged to a compensation accuracy within five percent of a centralized training baseline using data from all devices, while maintaining data privacy and reducing communication overhead by over ninety percent compared to centralized data collection schemes. This work addressed the practical deployment challenge of maintaining compensation model quality across large device populations subject to gradual drift and environmental change over their operational lifetimes.

Wu et al. (2023) developed a Siamese attention network specifically tailored for differential MEMS resonant accelerometer signal processing, incorporating both channel attention and spatial attention modules within the shared branch architecture to selectively amplify acceleration-correlated features and suppress common-mode noise. Their ablation study demonstrated that the combination of both attention types provided synergistic benefits beyond either type alone, and the full model achieved a bias stability improvement of forty percent over a Siamese network without attention on a thermal cycling dataset spanning minus fifty five to plus one hundred twenty five degrees Celsius. The network was further evaluated on a vibration isolation table and in field conditions aboard an unmanned aerial vehicle, demonstrating consistent compensation performance across diverse operational environments.

Deng et al. (2023) investigated the use of generative adversarial networks for data augmentation in MEMS resonant accelerometer compensation model training, generating synthetic sensor records spanning regions of the temperature-acceleration operating space that were sparsely sampled in the physical calibration dataset. The GAN-augmented training set improved compensation model accuracy by twelve percent in sparsely sampled regions while maintaining accuracy in well-sampled regions, demonstrating that generative data augmentation can partially substitute for expensive physical calibration measurements without introducing systematic bias into the learned compensation function.

Fang et al. (2024) presented an edge-deployable Siamese fusion network for real-time MEMS resonant accelerometer compensation, combining a lightweight MobileNet-inspired convolutional feature extractor with a cross-channel attention fusion module and a quantized inference engine optimized for deployment on ARM Cortex-M microcontrollers. The network achieved a compensation accuracy of fifteen microgravities over the full operating range at an inference latency of three milliseconds per sample on a Cortex-M33 processor, meeting the real-time requirements of precision inertial navigation while consuming only thirty-five milliwatts of processing power. The study further demonstrated robustness to integer quantization with less than two percent accuracy degradation compared to the floating-point reference model.

Yang et al. (2024) proposed a graph neural network framework for modeling the spatial distribution of thermal stress in MEMS resonant accelerometer dies, representing the physical device topology as a graph in which nodes correspond to structural elements and edges encode mechanical and thermal coupling relationships. The graph network learned to predict the stress distribution at each node from a sparse set of temperature sensor measurements, enabling spatially resolved thermal compensation without requiring a full array of on-chip thermometers. Compared to finite element interpolation using the same sensor inputs, the graph neural network achieved a twenty-five percent reduction in stress prediction error while operating with a computational latency compatible with real-time embedded implementation.

Huang et al. (2024) investigated meta-learning approaches for rapid adaptation of MEMS resonant accelerometer compensation models to new device variants or operational conditions, using model-agnostic meta-learning to train a

base model that can be fine-tuned to a specific device with as few as twenty labeled calibration samples. The meta-learned initialization provided substantially better few-shot calibration performance than transfer learning from a conventionally trained source model, achieving target device compensation accuracy within two percent of a fully calibrated reference model with ten times fewer calibration samples. This advance has important implications for production calibration efficiency and for field recalibration of sensors whose characteristics have drifted due to aging or mechanical shock.

Zhou et al. (2024) presented a comprehensive benchmarking study comparing twelve neural

network architectures for MEMS resonant accelerometer temperature compensation, evaluating each architecture on a common dataset of three hundred thousand frequency-temperature-acceleration records collected from twenty devices across three fabrication batches. The benchmark revealed that attention-based architectures consistently outperformed convolutional and recurrent baselines across all evaluated metrics, with the Siamese attention architecture achieving the lowest mean absolute compensation error of six microgravities and the best generalization across device batches, supporting the design choices motivating the present survey.

Comparative Table and Analysis

Study (Year)	Method / Model	System & Dataset	Key Contribution
Zou et al. (2014)	Analytical thermoelastic model	MEMS prototype; -40 to +85°C data	Foundational thermo-electro-mechanical coupling
Xia et al. (2016)	Differential resonator (DETF)	Silicon MEMS; thermal cycling	Temperature sensitivity suppression
Zhao et al. (2017)	Polynomial regression (DSP)	Embedded system; calibration dataset	TCO reduction using polynomial compensation
Erismis et al. (2018)	FEA multiphysics simulation	Simulation dataset	Coupled thermal-structural-electrostatic modeling
Tang et al. (2019)	ANN (RBF)	Triaxial accelerometer; 10k records	Temp + cross-axis compensation
Liu et al. (2019)	Modified thermoelastic model	DETF devices; geometry data	Design guidelines for quality factor
He et al. (2020)	CNN (ResNet-based)	IMU; spectrogram data	Direct spectral compensation
Zhang et al. (2020)	LSTM	MEMS accelerometer; thermal shock	Dynamic thermal compensation
Wang et al. (2020)	Gaussian + PINN	FEA dataset	Sample-efficient surrogate modeling
Chen et al. (2021)	Siamese CNN	Dual-resonator; paired data	Common-mode suppression
Li et al. (2021)	Transformer	Foot-mounted IMU	Multi-modal inertial fusion
Bao et al. (2021)	Feedback control	MEMS sensor	Nonlinearity suppression
Nguyen et al. (2021)	Transfer learning	Production MEMS	Reduced calibration cost
Park et al. (2022)	Pruned/quantized NN	ASIC IoT system	Model size reduction
Shen et al. (2022)	VAE	MEMS array; SHM data	Anomaly detection + compensation
Jiang et al. (2022)	Physics-guided NN	Hybrid dataset	Physics-integrated learning
Cui et al. (2022)	Gated fusion NN	Geodetic instrument	Dynamic sensor fusion
Miao et al. (2023)	Statistical model	Multi-device wafer data	Process variation compensation
Kim et al. (2023)	CNN-LSTM	Aerospace MEMS	Vibration error compensation

Luo et al. (2023)	Cross-attention NN	FPGA inertial system	Cross-axis sensitivity reduction
Sharma et al. (2023)	Federated learning	IoT sensor network	Privacy-preserving calibration
Wu et al. (2023)	Siamese + attention	UAV test data	Bias stability improvement
Deng et al. (2023)	GAN	Calibration dataset	Data augmentation
Fang et al. (2024)	Lightweight Siamese	Edge MCU	Fast, low-power inference
Yang et al. (2024)	Graph NN	MEMS die sensors	Spatial thermal compensation
Huang et al. (2024)	Meta-learning	Few-shot data	Reduced calibration samples
Zhou et al. (2024)	Benchmarking	Large multi-device dataset	Identifies best NN architectures

Comparative Analysis

A careful survey of the literature tabulated above reveals several clear and consistent trends that define the current trajectory of MEMS resonant accelerometer compensation research. The earliest works in the reviewed corpus were dominated by analytical and finite element modeling approaches, reflecting the engineering community's initial reliance on physics-based understanding of thermo-electro-mechanical coupling to derive correction algorithms. These model-based methods, while theoretically grounded and physically interpretable, demonstrated a clear ceiling in compensation performance arising from the practical impossibility of capturing all relevant coupling phenomena in analytically tractable models, particularly for the packaging-induced stress effects and process variation contributions that are inherently statistical in nature.

The transition toward data-driven compensation methods accelerated markedly from 2019 onward, with feedforward neural networks and polynomial regression giving way to progressively more sophisticated architectures including deep convolutional networks, recurrent networks, attention-based transformers, and Siamese architectures. This architectural evolution reflects a broader trend in the machine learning field but is particularly well-matched to the characteristics of the MEMS compensation problem, where the input-output relationship is nonlinear, high-dimensional, and context-dependent in ways that motivate both deep representation learning and attention-based selective processing. The progression from single-input feedforward networks to multi-modal fusion architectures tracks the growing recognition that exploiting multiple sensing channels, including temperature sensors, reference accelerometers, and multi-

axis resonators, provides substantially richer information for compensation than any single channel alone.

The Siamese architecture has emerged as a consistently high-performing approach across multiple studies, with Chen et al. (2021), Wu et al. (2023), and Fang et al. (2024) all demonstrating substantial advantages over non-Siamese baselines on differential MEMS accelerometer platforms. The weight-sharing constraint inherent to Siamese processing provides an architectural inductive bias well matched to the differential measurement principle, and the combination of Siamese structure with attention mechanisms, as demonstrated by Wu et al. (2023), appears to represent a particularly effective design choice that merits further investigation and systematic evaluation. The consistency of attention mechanism benefits across diverse architectural contexts, from transformers to Siamese networks to graph neural networks, suggests that selective feature weighting is a fundamentally important capability for MEMS sensor signal processing that should be considered a standard architectural component in future neural compensation designs.

Hardware deployment considerations have emerged as an increasingly prominent theme in the recent literature, reflecting the transition of neural MEMS compensation from laboratory demonstration toward practical embedded deployment. The progression from general-purpose GPU training platforms through automotive-grade microcontrollers, ARM Cortex-M processors, and co-packaged mixed-signal ASICs represents a practical hardware-efficiency optimization trajectory that must continue if neural compensation is to achieve the power and cost targets required for volume production in consumer and automotive applications. The network compression

techniques employed in Park et al. (2022) and Fang et al. (2024), including structured pruning, quantization, and architecture-level efficiency optimization, demonstrate that substantial size and power reductions are achievable without unacceptable accuracy penalties, but the field would benefit from more systematic studies of the accuracy-efficiency trade-off frontier across different MEMS compensation scenarios.

Discussion

The reviewed literature highlights a rapidly evolving research landscape shaped by the convergence of advanced MEMS device design and modern deep learning techniques. Traditional analytical and low-order modeling approaches, while effective in explaining thermo-electro-mechanical behavior, have proven insufficient to fully address the nonlinear complexities of MEMS resonant accelerometer compensation. This limitation has driven a clear shift toward data-driven methods, particularly neural networks, which demonstrate strong adaptability across diverse operating conditions and platforms. Overall, the evidence suggests that learned compensation techniques provide a more robust and accurate solution for high-precision MEMS sensor performance.

Among the various architectures explored, attention-based mechanisms emerge as a particularly effective advancement. Their ability to dynamically prioritize relevant features aligns closely with the physical behavior of MEMS systems, where different signal components dominate under varying conditions such as temperature or vibration. By adaptively focusing on the most informative features, attention models enable more flexible and context-aware compensation compared to static filtering methods. Empirical results, especially from recent benchmarking studies, confirm that attention-based models consistently outperform traditional and earlier neural approaches.

Another important trend is the integration of physical knowledge into neural networks through physics-informed learning. These approaches address key concerns related to reliability and generalization, particularly in safety-critical domains like aerospace and automotive systems. By embedding governing physical laws into the learning process, such models maintain consistency even in scenarios outside the training data, reducing the risk of unexpected failures. This combination of data-driven learning with physical constraints enhances both trustworthiness and operational robustness.

Despite these advancements, several challenges remain. Calibration efficiency continues to be a practical concern, as high-accuracy models often require extensive device-specific data. Emerging techniques such as transfer learning, meta-learning, and federated learning aim to reduce this burden, making large-scale deployment more feasible. Additionally, there is limited research on long-term model stability, with most studies focusing on short evaluation periods. Future work should prioritize adaptive learning over time and establish standardized benchmarks to ensure consistent and comparable evaluation across studies.

Conclusion

This survey provides a comprehensive overview of methods used to enhance the thermo-electro-mechanical performance of MEMS resonant accelerometers, highlighting the growing dominance of deep learning, particularly attention-guided Siamese fusion networks. While early approaches relied heavily on physics-based modeling and classical compensation, modern techniques increasingly adopt data-driven paradigms that better capture nonlinear interactions among thermal, mechanical, and electrostatic effects. MEMS accelerometers play a critical role in high-precision applications such as UAV navigation, microsatellites, and portable systems, where demands for accuracy under varying environmental conditions continue to intensify. Neural network-based compensation has demonstrated significant improvements over traditional methods, often achieving substantial gains in accuracy and robustness. Key architectural strengths include Siamese networks for differential signal processing and attention mechanisms for adaptive feature selection, enabling context-aware noise suppression. Furthermore, integrating physical knowledge into neural models improves reliability and generalization, addressing concerns about unpredictable behavior in safety-critical scenarios. Despite these advancements, challenges such as calibration cost, long-term stability, and deployment constraints remain. Emerging solutions like transfer learning, meta-learning, and federated learning aim to reduce calibration effort, while future research must address continual learning for device aging and drift. Additionally, improving interpretability, uncertainty estimation, and hardware-software co-design will be essential for real-world adoption. Overall, the fusion of deep learning with MEMS sensor physics represents a promising and scalable

pathway for next-generation intelligent sensing systems.

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